- Meets or Exceeds the Requirements of IBM™ System 360 Input/Output Interface Specification
- Operates From Single 5-V Supply
- TTL Compatible
- Built-In Input Threshold Hysteresis
- High Speed . . . Typical Propagation Delay Time = 20 ns
- Independent Channel Strobes
- Input Gating Increases Application Flexibility
- Designed for Use With Dual Line Driver SN75123
- Designed to Be Interchangeable With Signetics N8T24

1A [16 V_{CC} 1B **1** 2 15 1S 2R 🛮 3 14 🛮 1R 2S [13**∏** 1Y 12 3A 2A ∏ 11 38 2В П 6 2Y 🛮 7 10**∏** 3R GND 8 9 3Y

D OR N PACKAGE (TOP VIEW)

description

The SN75124 triple line receiver is specifically designed to meet the input/output interface specifications for IBM System 360. It is also compatible with standard TTL logic and supply voltage levels.

The SN75124 has receiver inputs with built-in hysteresis to provide increased noise margin for single-ended systems. An open line affects the receiver input as does a low-level input voltage, and the receiver input can withstand a level of -0.15 V with power on or off. The other inputs are in TTL configuration. The S input must be high to enable the receiver input. Two of the line receivers have A and B inputs that, if both are high, hold the output low. The third receiver has only an A input that, if high, holds the output low.

See the SN751730 for new IBM 360/370 interface designs.

The SN75124 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

	INPUTS							
Α	в†	R	S	Y				
Н	Н	Х	Χ	L				
Х	X	L	Н	L				
L	X	Н	Χ	Н				
L	X	X	L	Н				
Х	L	Н	Χ	Н				
Х	L	Χ	L	Н				

†B input and last two lines of the function table are applicable to receivers 1 and 2 only.



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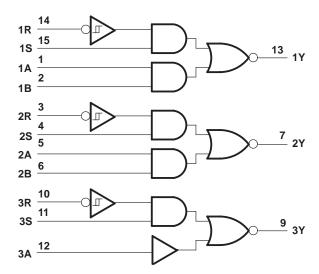


logic symbol[†]

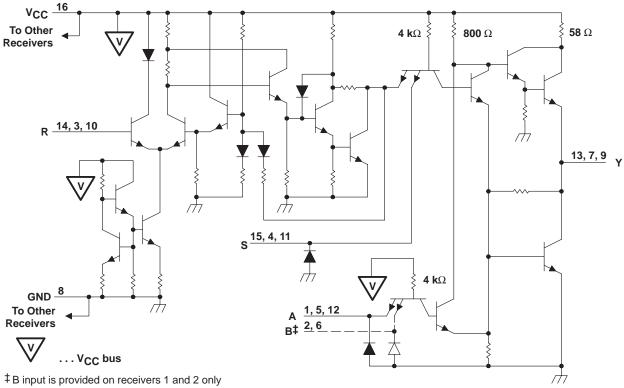
14 & ≥ 1 1R 13 — 1Y 15 18 1 1A 1B 3 2R 2S 7 5 2Y 2A 6 2B ≥ 1 & 10 3R 11 3Y 3S 12 3A

[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematic (each receiver)



F B input is provided on receivers 1 and 2 only Resistor values shown are nominal.

SLLS058B - SEPTEMBER 1973 - REVISED MAY 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	
Input voltage, V _I : R input with V _{CC} applied	7 \
R input with V _{CC} not applied	
A, B, or S input	
Output voltage, VO	7\
Output current, IO	
Continuous total dissipation	. See Dissipation Rating Table
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stq}	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

NOTE 1: Voltage values are with respect to network ground terminal

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{A}} \leq 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW
N	1150 mW	9.2 mW/°C	736 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.75	5	5.25	V	
High lovel input voltage. V.	A, B, or S	2			V
High-level input voltage, V _{IH}	R	1.7			V
Low-level input voltage, V _{IL}	A, B, or S			0.8	V
	R			0.7	V
High-level output current, IOH			-800	μΑ	
Low-level output current, I _{OL}				16	mA
Operating free-air temperature, T _A				70	°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CON	MIN	TYP	MAX	UNIT		
V _{hys}	Hysteresis voltage (V _{IT+} – V _{IT} –)	R	$V_{CC} = 5 V$,	T _A = 25°C	0.2	0.5		V
VIK	Input clamp voltage	A, B, or S	$V_{CC} = 5 V$,	I _I –12 mA			-1.5	V
V _{I(BR)}	Input breakdown voltage	A, B, or S	$V_{CC} = 5 V$,	I _I = 10 mA	5.5			V
Vон	Vou. High-level output voltage		$V_{IH} = V_{IH}$ min, $I_{OH} = -800 \mu A$,	V _{IL} = V _{IL} max, See Note 2	2.6			٧
VOL			V _{IH} = V _{IH} min, I _{OL} = 16 mA,	V _{IL} = V _{IL} max, See Note 2			0.4	V
1.	lanut aumant at maximum innut valtage	R	V _I = 7 V				5	A
11	Input current at maximum input voltage		V _I = 6 V,	VCC = 0			5	mA
1	High level input ourrent	A, B, or S	V _I = 4.5 V				40	
l'IH	High-level input current	R	V _I = 3.11 V				170	μА
I _{IL}	Low-level input current A, B, or S		V _I = 0.4 V,	V _{IR} = 0.8 V	-0.1		-1.6	mA
los	Short-circuit output current [†]				-50		-100	mA
loo	Supply current		All inputs = 0.8 V				72 m/	mA
'cc	очрріу сипені	2	All inputs = 2 V	_			100	IIIA

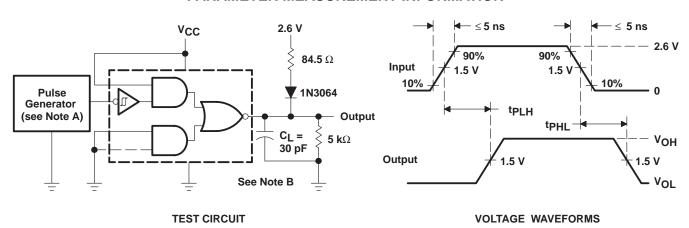
[†] Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 2: The output voltage and current limits are characterized for any appropriate combination of high and low inputs specified by the function table for the desired output.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output from R input	See Figure 1		20	30	20
tPHL	Propagation delay time, high-to-low-level output from R input	See Figure 1		20	30	ns

PARAMETER MEASUREMENT INFORMATION



NOTES: A. The pulse generator has the following characteristics: $Z_O \approx 50 \ \Omega$, PRR $\leq 5 \ MHz$, duty cycle = 50%.

B. C_L includes probe and jig capacitance.

Figure 1. Test Circuit and Voltage Waveforms



TYPICAL CHARACTERISTICS

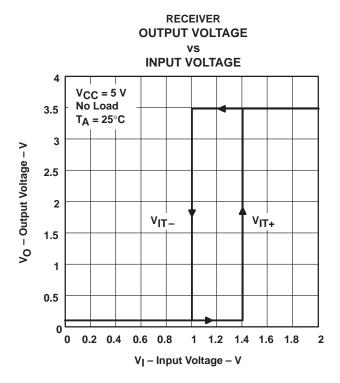


Figure 2

APPLICATION INFORMATION

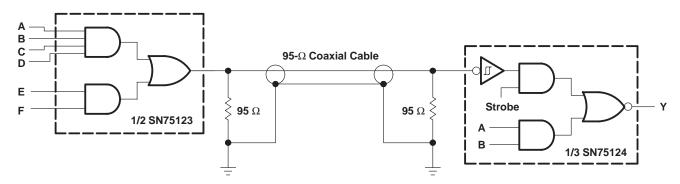


Figure 3. Unbalanced Line Communication Using SN75123 and SN75124



PACKAGE OPTION ADDENDUM

6-Feb-2020

PACKAGING INFORMATION

www.ti.com

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN75124N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	SN75124N	Samples
SN75124NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75124	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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6-Feb-2020

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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